

#### MICROPOWER OMNIPOLOAR HALL-EFFECT SENSOR SWITCH

### Description

AH180 is a micro-power Omnipolar Hall-Effect switch designed for portable and battery powered equipment such cellular phones, PDAs and portable PCs. Based on two Hall-Effect plates and a chopper stabilized architecture the AH180 provides a reliable solution over the whole operating range. To support portable and battery powered equipment the design has been optimized to operate over the supply range of 2.5V to 5.5V and consumes only 24uW with a supply of 3V.

The single open-drain output switches on with either a north or south pole of sufficient strength.

When the magnetic flux density (**B**) is larger than operate point (**Bop**), output is switched on (Output pin is pulled low). The output is turned off when **B** becomes lower than the release point (**Brp**). The output will remain off when there is no magnetic field.

The AH180 is available in SIP-3L, SC59, DFN2020-3, and DFN2020-6 packages.

#### Features

- Omnipolar (north or south pole) operation
- Micropower operation
- Single open drain output
- 2.5V to 5.5V operating voltage
  - Chopper stabilized design provides
  - Superior temperature stability
  - Minimal switch-point drift
  - Enhanced immunity to stress
- Good RF noise immunity
- -40°C to +85°C operating temperature
- ESD (HBM) > 5KV for DFN2020-6, DFN2020-3 > 6KV for SIP-3L and SC59
- SIP-3L, SC59 (commonly known as SOT23 in Asia) DFN2020-6, DFN2020-3 packages
- Green Molding Compound (No Br, Sb) (Note 1)

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.





#### Applications

- Cover Switch in Clam-Shell Cellular Phones
- Cover Switch in Notebook PC/PDA
- Contactless Switch in Consumer Products



# **Typical Application Circuit**



Note: C is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF~100nF. RL is the pull-up resistor, the recommended resistance is 10Kohm~100Kohm.

## **Pin Descriptions**

Pin Name	P/I/O		Description	
Vdd	P/I	Power Supply Input		
GND	P/I	Ground		
Output	0	Output Pin		
NC	NC	No Connected		

# **Functional Block Diagram**





## Absolute Maximum Ratings (T<sub>A</sub> = +25°C)

Symbol	Chara	Values	Unit			
Vdd	Supply voltage	7	V			
В	Magnetic flux density	Unlimited				
Ts	Storage Temperature Range	-65 to +150	°C			
		SIP-3L	550	mW		
P <sub>D</sub>	Package Power Dissipation	SC59-3L/ DFN2020-6/ DFN2020-3	230	mW		
TJ	Maximum Junction Temperature	150	°C			

## **Recommended Operating Conditions**

Parameter	Conditions	Min	Мах	Unit
Supply Voltage	Operating	2.5	5.5	N
Operating Ambient Temperature	Operating	-40	85	O°
	Supply Voltage	Supply Voltage Operating	Supply Voltage Operating 2.5	Supply Voltage Operating 2.5 5.5

# Electrical Characteristics (T<sub>A</sub> = +25°C, Vdd = 3V; unless otherwise specified)

Symbol	Characteristic	Conditions	Min	Тур.	Мах	Unit
Vout	Output On Voltage	lout =1mA	_	0.1	0.3	V
loff	Output Leakage Current	Vout =5.5V, Output off		<0.1	1	μA
ldd(en)		Chip enable, $T_A = +25^{\circ}C$ , Vdd = 3V		3	6	mA
ldd(en)		Chip enable, $T_A = -40 - 85^{\circ}C$ , Vdd = 2.5-5.5V	_	3	9	mA
Idd(dis)		Chip disable, $T_A = +25$ °C, Vdd = 3V		5	10	μA
ldd(dis)	Supply Current	Chip disable, T <sub>A</sub> = -40~85°C, Vdd = 2.5~5.5V	_	5	15	μΑ
ldd(avg)		Average supply current, $T_A = +25^{\circ}C$ , Vdd = 3V	_	8	16	μΑ
ldd(avg)		Average supply current, T <sub>A</sub> = -40~85°C, Vdd = 2.5~5.5V		8	24	μΑ
Tawake	Awake Time	(Note 2)		75	125	μs
Tperiod	Period	(Note 2)		75	125	ms
D.C.	Duty Cycle			0.1	_	%



2. When power is initially turned on, Vdd must be within its correct operating range (2.5V to 5.5V) to guarantee the output sampling. The output state is valid after the second operating phase (typical 150ms).





# Magnetic Characteristics (T<sub>A</sub> = +25°C, Vdd = 3V, Notes 3 & 4)

Option 1: (1mT=10 Gauss)										
Symbol	Parameter	Min	Тур.	Max	Unit					
Bops (south pole to brand side)	Operation Daint	-	40	60						
Bopn (north pole to brand side)	Operation Point	-60	-40	-						
Brps (south pole to brand side)	Delases Deist	10	30	-	Gauss					
Brpn (north pole to brand side)	Release Point	-	-30	-10						
Bhy ( Bopx - Brpx )	Hysteresis	-	15	-	1					

Option 2: (1mT=10									
Parameter	Min	Тур.	Max	Unit					
Operation Daint	-	40	60						
Operation Point	-60	-40	-						
Delege Deint	20	30	-	Gauss					
Release Point	-	-30	-20						
Hysteresis	-	15	-						
	Operation Point     Release Point	Operation Point     Operation Point     Content C	Operation Point         -         40           Release Point         20         30           -         -30         -	Operation Point         -         40         60           Release Point         -					

 Notes:
 3. Typical data is at T<sub>A</sub> = +25°C, Vdd = 3V, and for design information only.

 4. Magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

## Operating Characteristics





## **Performance Characteristics**

#### (1) SIP-3L

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	95	100
P <sub>D</sub> (mW)	550	440	396	352	308	286	264	242	220
T <sub>A</sub> (°C)	105	110	115	120	125	130	135	140	150
P <sub>D</sub> (mW)	198	176	154	132	110	88	66	44	0



(2) SC59 (commonly known as SOT23 in Asia), DFN2020-6 and DFN2020-3

T <sub>A</sub> (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P <sub>D</sub> (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0





#### **Ordering Information**





#### Marking Information (cont.)

(2) SC59 (commonly known as SOT23 in Asia)



# Package Outline Dimensions (All Dimensions in mm)

#### (1) Package Type: SIP-3L for Bulk pack





(2) Package Type: SIP-3L for Ammo pack





#### (4) Package Type: DFN2020-6





(1) DFN2020-6



Note: 12. The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.



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